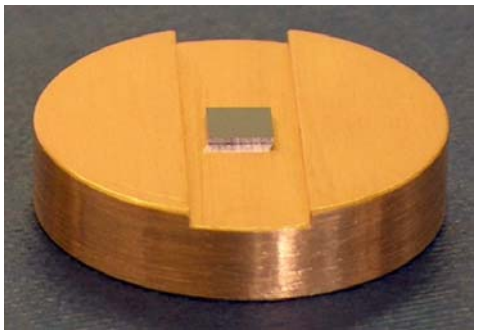
Mounted RSAM data sheet RSAM-λ-25.0g

GaAs chip area	standard:	4mm x 4mm
	optional:	other dimensions on request
Chip thickness	standard:	400 µm
Front side	the RSAM is covered by a dielectric front mirror.	

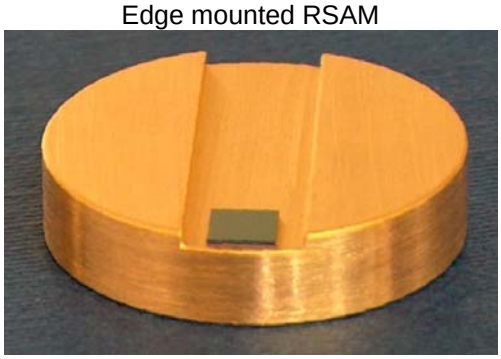
The RSAM chip is glued on a gold plated Cu-cylinder with 25.0 mm Ø using a thermal conducting paste.

- The ***standard*** position of the RSAM is at the center of the mount.
- ***Optional*** the RSAM can be mounted on the edge of the mount without extra charges.

Center mounted RSAM

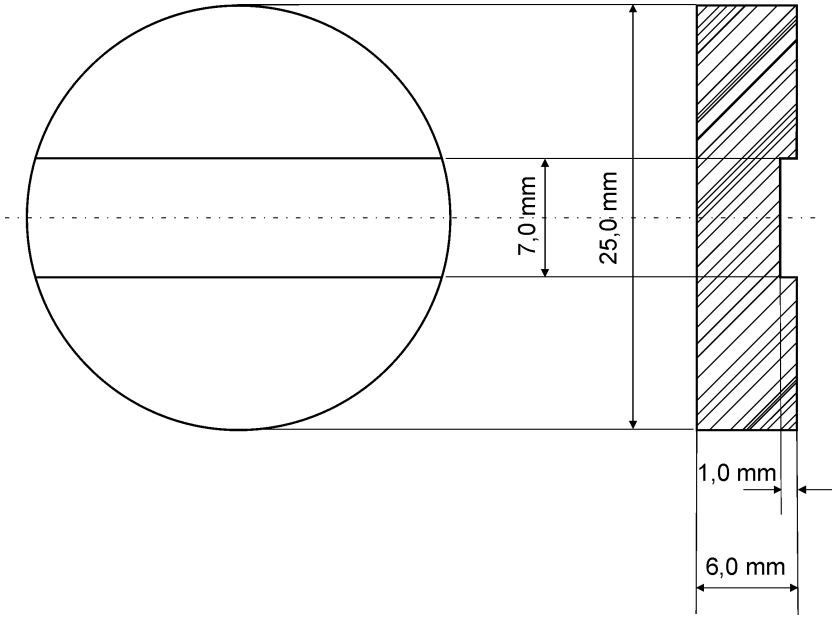


Edge mounted RSAM



Mount

Cu-cylinder, ∅ = 25.0 mm
l = 6.0 mm



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